

*Preliminary Specifications Subject to Change without Notice*

## DESCRIPTION

The JWH<sup>®</sup>5276 is a monolithic buck switching regulator based on a proprietary I<sup>2</sup> control for fast transient response. Operating with an input range of 2.95V~7V, JWH5276 delivers 6A of continuous output current with integrated two MOSFETs. The internal synchronous power switches provide high efficiency without the use of an external schottky diode.

JWH5276 guarantees robustness with output short protection, thermal protection, current run-away protection, and input under voltage lockout.

JWH5276 is available in QFN3X3-16 packages, which provide a compact solution with minimal external components.

Company's Logo is Protected, "JW" and "JOULWATT" are Registered Trademarks of JoulWatt technology Inc.

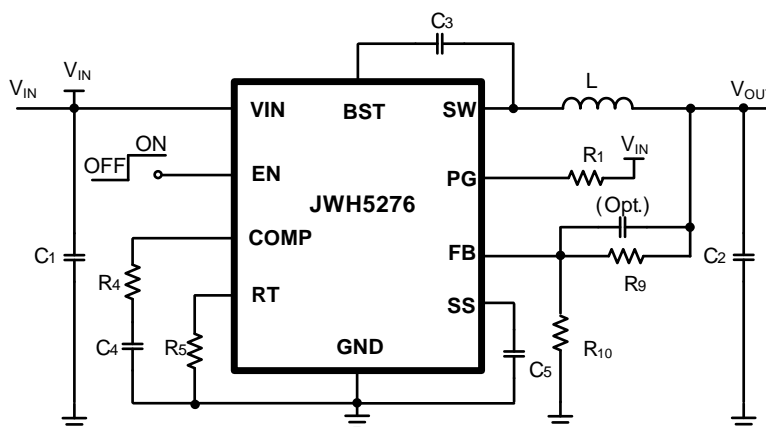
## FEATURES

- 2.95V to 7V operating input range
- Up to 6A output current
- Internal 12mΩ High-Side and 12mΩ Low-Side MOSFETs
- Adjustable switching frequency
- Adjustable soft-start time
- Power good indicator
- Input under voltage lockout
- Output short circuit protection
- Thermal protection
- Available in QFN3X3-16 package

## APPLICATIONS

- Low-voltage, High Density Power System
- POL Regulation for High-performance DSPs, FPGAs, ASICs and Microprocessors
- Gaming, DTV and Set-top Boxes
- Hard Disk Drives

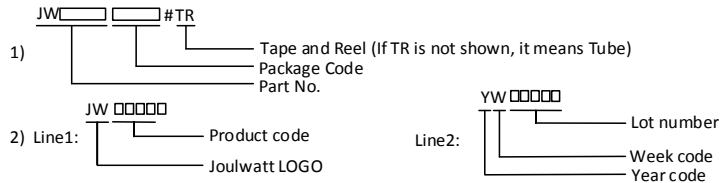
## TYPICAL APPLICATION



## ORDER INFORMATION

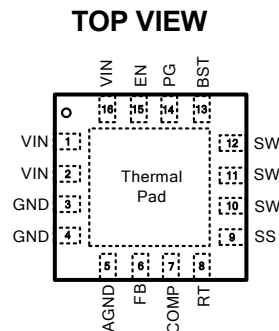
DEVICE <sup>1)</sup>	PACKAGE	TOP MARKING <sup>2)</sup>	ENVIRONMENTAL <sup>3)</sup>
JWH5276QFNA#TR	QFN3X3-16	JWH5276 YW□□□□	Green

## Notes:



3) All Joulwatt products are packaged with Pb-free and Halogen-free materials and compliant to RoHS standards.

## PIN CONFIGURATION

ABSOLUTE MAXIMUM RATING<sup>1)</sup>

Input Supply Voltage ( $V_{IN}$ )	-0.3V to 8V
EN Voltage ( $V_{EN}$ )	-0.3V to 8V
PG Voltage ( $V_{PG}$ )	-0.3V to 8V
SW Voltage ( $V_{SW}$ )	-0.3V(-2V for 20ns; -4V for 5ns) to 8V(10V for 20ns; 12V for 5ns)
BST Voltage ( $V_{BST}$ )	$V_{SW} + 4V$
FB, COMP, SS, RT Pins	-0.3V to 4V
Operating Junction Temp. <sup>2)</sup>	-40 °C ~150°C
Storage Junction Temp. <sup>2)</sup>	-65 °C ~150°C
Lead Temperature	260°C

## ESD RATINGS

Human body model (HBM), per ANSI/ESDA/JEDEC JS-001	±2000V
Charged device model (CDM), per JEDEC specification JESD22- V C101	±500V

**RECOMMENDED OPERATING CONDITIONS<sup>3)</sup>**

Input Voltage $V_{IN}$ .....	2.95V to 7V
Output Voltage $V_{OUT}$ .....	0.6V to $V_{IN} \cdot D_{max}$

**THERMAL PERFORMANCE<sup>4)</sup>**

	$\theta_{JA}$	$\theta_{JC}$
QFN3X3-16.....	44.....	4.1°C/W

**Notes:**

- 1) Exceeding these ratings may damage the device. These stress ratings do not imply function operation of the device at any other conditions beyond those indicated under RECOMMENDED OPERATING CONDITIONS.
- 2) The JWH5276 includes thermal protection that is intended to protect the device in overload conditions. Continuous operation over the specified absolute maximum operating junction temperature may damage the device.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB

## ELECTRICAL CHARACTERISTICS

$V_{IN}=5V$ , $T_J=-40^{\circ}C \sim 150^{\circ}C$ , Unless otherwise stated.						
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
$V_{IN}$ Under Voltage Lock-out Rising Threshold	$V_{IN\_R}$	$V_{IN}$ rising	2.6	2.77	2.9	V
$V_{IN}$ Under Voltage Lock-out Falling Threshold	$V_{IN\_F}$	$V_{IN}$ falling	2.31	2.48	2.61	V
Shutdown Supply Current	$I_{SD}$	$V_{EN}=0V$ , $T_A=25^{\circ}C$		1.7	3	$\mu A$
Supply Current	$I_Q$	$V_{EN}=2V$ , $V_{FB}=1V$ , Non-switching		300	500	$\mu A$
Feedback Voltage	$V_{FB}$	$2.95V \leq V_{IN} \leq 7V$	594	600	606	mV
Top Switch Resistance	$R_{DS(ON)T}$	$I_{SW} = 500mA$		12	20	m $\Omega$
Bottom Switch Resistance	$R_{DS(ON)B}$	$I_{SW} = 500mA$		12	20	m $\Omega$
Top Switch Leakage Current	$I_{LEAK\_TOP}$	$V_{IN}=7V$ , $V_{EN}=0V$ , $V_{SW}=0V$ , $T_J=25^{\circ}C$		0.1		$\mu A$
Bottom Switch Leakage Current	$I_{LEAK\_BOT}$	$V_{IN}=7V$ , $V_{EN}=0V$ , $V_{SW}=7V$ , $T_J=25^{\circ}C$		0.1		$\mu A$
Error Amplifier Transconductance	$g_m$	$V_{COMP}=1V$		260		$\mu A/V$
Error Amplifier Source and Sink		$V_{COMP}=1V$ , 100mV overdrive		$\pm 22$		$\mu A$
COMP to $I_{switch}$ gain				14		A/V
Top Switch Current Limit	$I_{LIM\_TOP}$		9.5	10.5	12.5	A
Bottom Switch Current Limit	$I_{LIM\_BOT}$		6	7.5	9.5	A
Bottom Switch Negative Current Limit	$I_{LIM\_BOT\_NEG}$			-4.5		A
Cycles Before Entering Hiccup During OC <sup>5)</sup>				4150		cycle
Hiccup Off Time <sup>5)</sup>			12	16	20	ms
EN Rising Threshold Voltage	$V_{EN\_H}$		1.25	1.3	1.35	V
EN Falling Threshold Voltage	$V_{EN\_L}$		1.13	1.18	1.23	V
EN Input Current	$I_{EN\_H}$	$V_{EN\_H} +50mV$		-3.5		$\mu A$
	$I_{EN\_L}$	$V_{EN\_L} -50mV$		-0.55		$\mu A$
EN Turn On Delay <sup>5)</sup>	$T_{ON\_Delay}$	From EN high to switching, $T_J=+25^{\circ}C$		70	200	$\mu s$
Power Good Output Low	$V_{PG\_OL}$	$I_{PG}=-2.5mA$			0.3	V
Power Good Lower Threshold Voltage	$V_{PG\_TH\_L}$	FB rising	90%	93.5%	97%	$V_{REF}$
		FB falling	88%	91.5%	95%	$V_{REF}$
Power Good Upper Threshold Voltage	$V_{PG\_TH\_H}$	FB rising	113%	116.5%	120%	$V_{REF}$
		FB falling	111%	114.5%	118%	$V_{REF}$

$V_{IN}=5V$ ,  $T_J=-40^{\circ}C \sim 150^{\circ}C$ , Unless otherwise stated.

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power Good Delay Time	$t_{PG\_DLY1}$	PG from low to high	10	15	20	$\mu s$
	$t_{PG\_DLY2}$	PG from high to low	8	13	18	$\mu s$
Soft-Start Charge Current	$I_{SS\_CHAR}$	$V_{SS} > 0.1V$	1.5	2	2.5	$\mu A$
		$V_{SS} < 0.1V$	30	39	50	$\mu A$
Soft-Start Discharge Current	$I_{SS\_DIS\ CHAR}$	$V_{SS}=4V$	1	2.8		mA
Switching Frequency Range	$F_{SW}$	$I_{OUT} = 1A$	400		2000	kHz
Switching Frequency	$F_{SW}$	$R_T = 39.2\ k\Omega$	850	1000	1150	kHz
RT Voltage		$R_T = 39.2\ k\Omega$		0.5		V
Minimum On-Time <sup>5)</sup>	$t_{ON\_MIN}$			110	130	ns
Minimum Off-Time	$t_{OFF\_MIN}$			80	110	ns
Thermal Shutdown <sup>5)</sup>	$T_{TSD}$			170		$^{\circ}C$
Thermal Shutdown hysteresis <sup>5)</sup>	$T_{TSD\_HYST}$			20		$^{\circ}C$

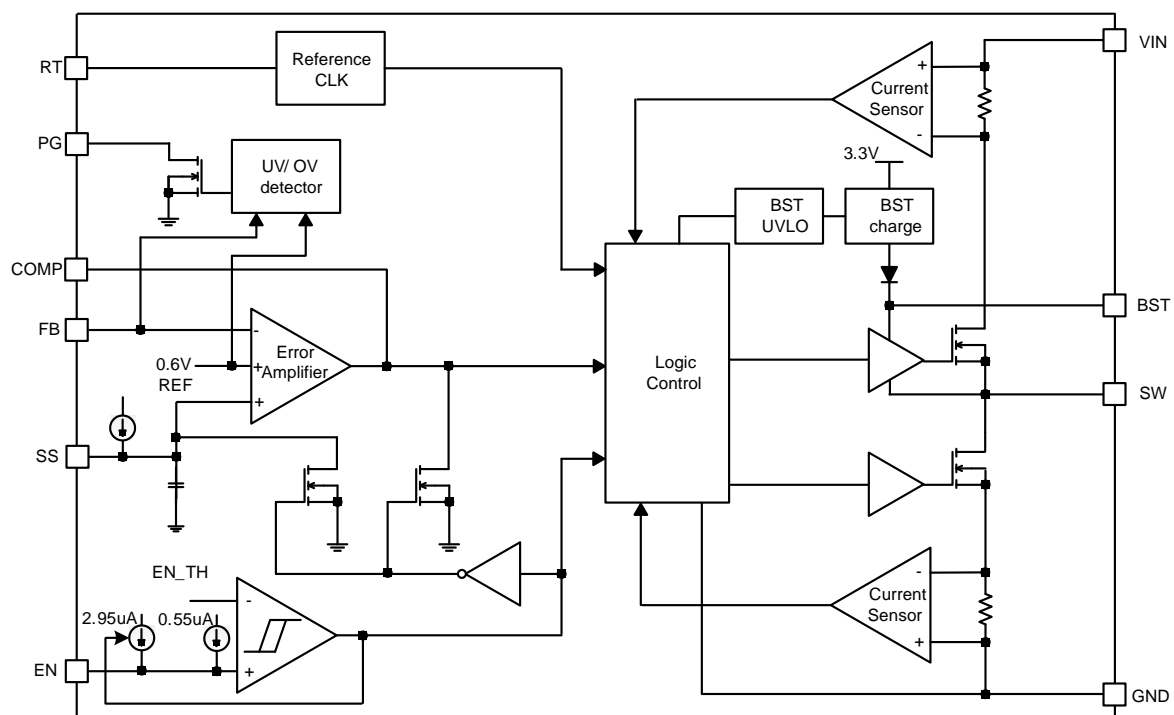
### Note:

5) Guaranteed by design.

## PIN DESCRIPTION

Pin	Name	Description
1, 2, 16	VIN	Supply voltage for power stage. Connect a 2.95V to 7V supply to VIN and bypass VIN to GND with a suitably large capacitor to eliminate noise on the input to the IC.
3, 4	GND	Ground pin.
5	AGND	Analog ground should be tied to GND close to the device.
6	FB	Output feedback pin. FB senses the output voltage and is regulated by the control loop to 0.6 V. Connect a resistive divider at FB.
7	COMP	Error amplifier output, and input to the output switch current comparator. Connect frequency compensation components to this pin.
8	RT	Switching frequency setting pin.
9	SS	Soft-start time setting pin
10, 11, 12	SW	SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load.
13	BST	Connect a 0.1uF capacitor between BST and SW pin to supply current for the top switch driver.
14	PG	Output power good indicator (High= $V_{OUT}$ ready, Low= $V_{OUT}$ below nominal regulation); open drain (requires pull-up resistor).
15	EN	Drive EN pin high to turn on the regulator and low to turn off the regulator. Float to enable.
	Exposed Pad	GND pin must be connected to the exposed power pad for proper operation. This power pad should be connected to any internal PCB ground plane using multiple vias.

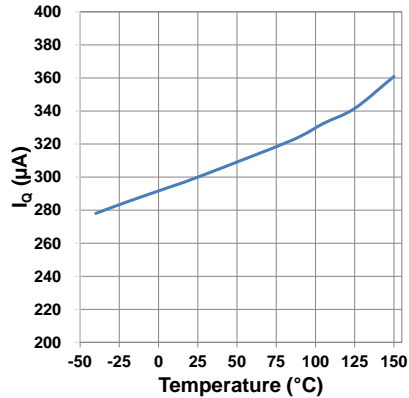
## BLOCK DIAGRAM



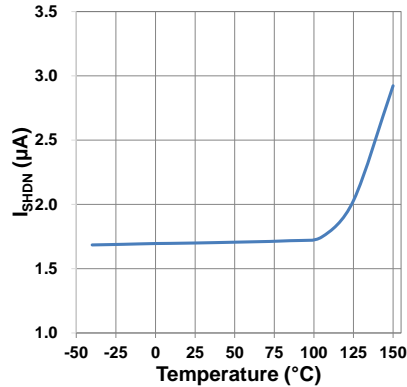
## TYPICAL CHARACTERISTICS

VIN = 5V, TJ = -40°C to +150°C, unless otherwise noted

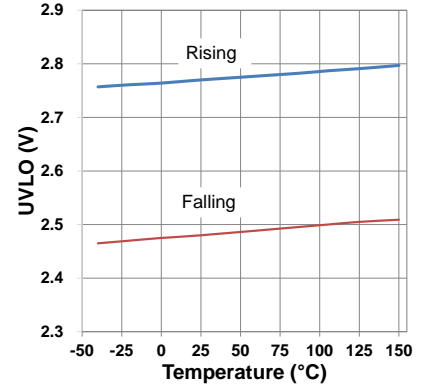
Quiescent Current vs. Temperature



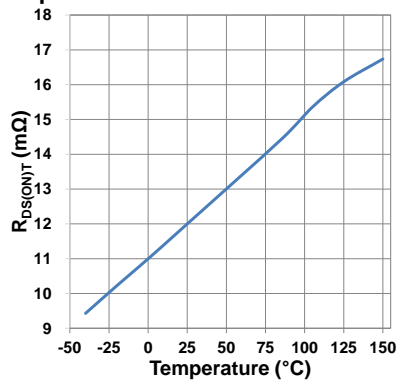
Shutdown Current vs. Temperature



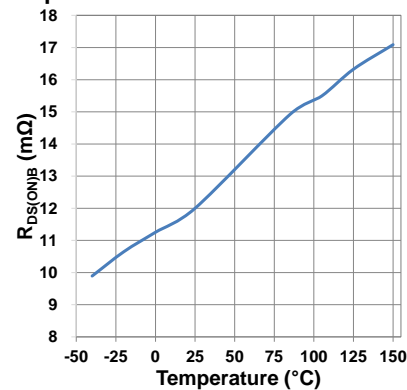
VIN UVLO Threshold vs. Temperature



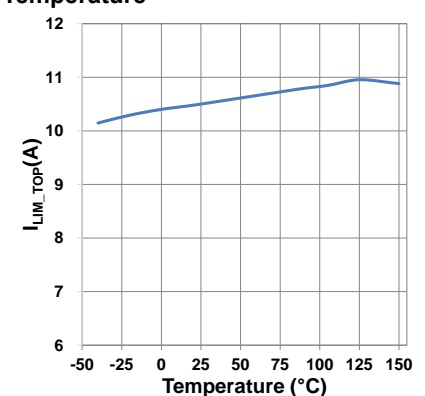
Top Switch Resistance vs. Temperature



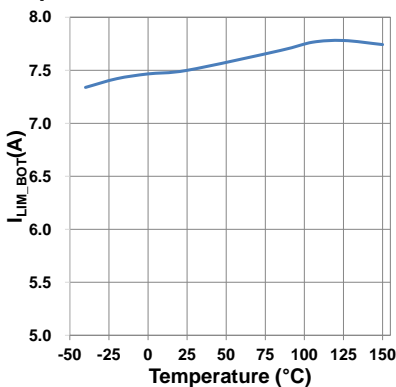
Bottom Switch Resistance vs. Temperature



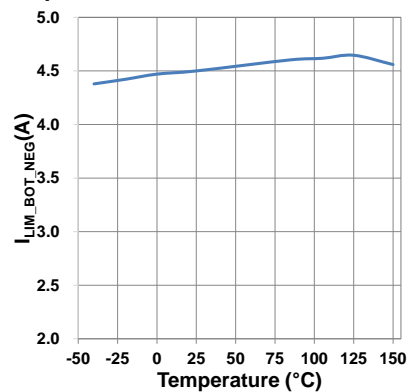
Top Switch Current Limit vs. Temperature



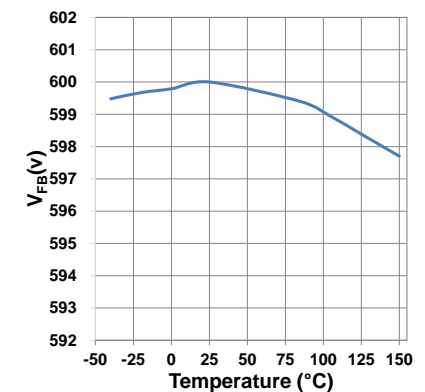
Bottom Switch Current Limit vs. Temperature



Negative Current Limit vs. Temperature



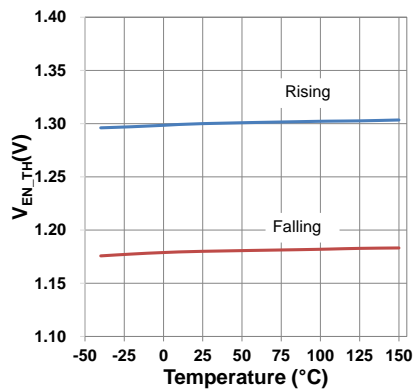
Feedback Voltage vs. Temperature



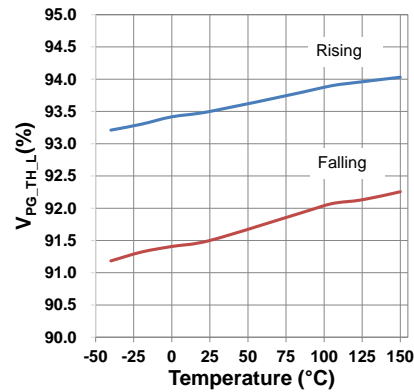
## TYPICAL CHARACTERISTICS (Continued)

VIN = 5V, T<sub>J</sub> = -40°C to +150°C, unless otherwise noted

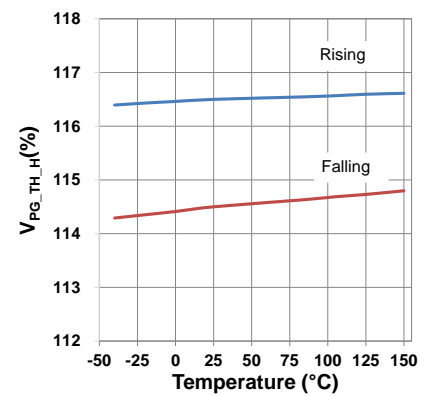
EN Threshold vs. Temperature



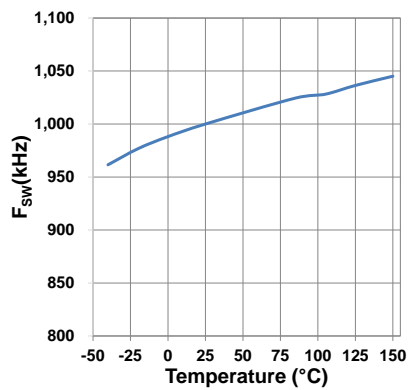
PG Lower Threshold vs. Temperature



PG Upper Threshold vs. Temperature



Frequency vs. Temperature



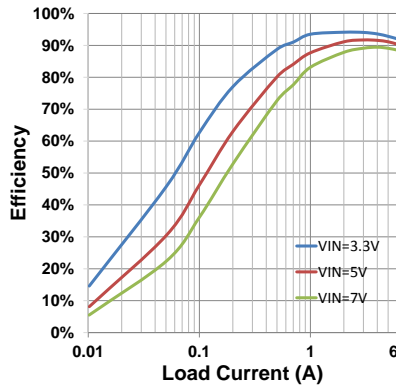


## TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN} = 5V$ ,  $V_{OUT} = 1.2V$ ,  $L = 0.33\mu H$ ,  $C_{OUT} = 104\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.

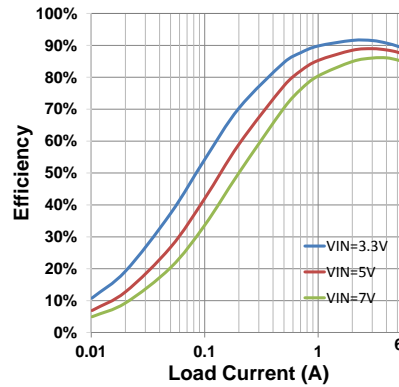
### Efficiency vs. Load Current

$V_{OUT}=1.8V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$



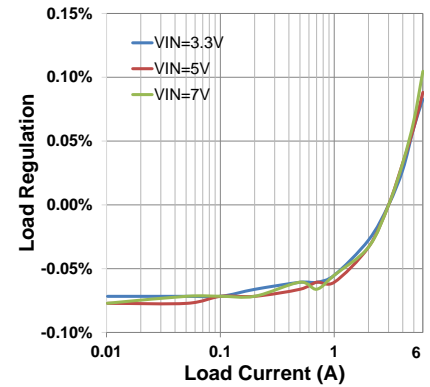
### Efficiency vs. Load Current

$V_{OUT}=1.2V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$



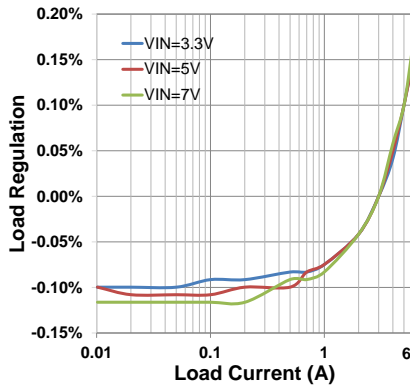
### Load Regulation

$V_{OUT}=1.8V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$



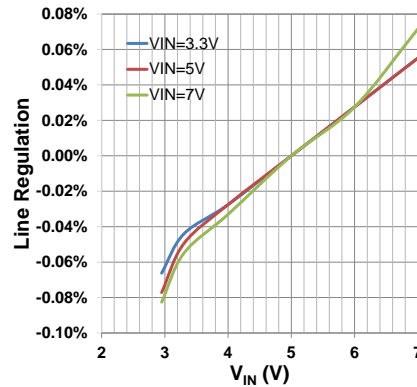
### Load Regulation

$V_{OUT}=1.2V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$



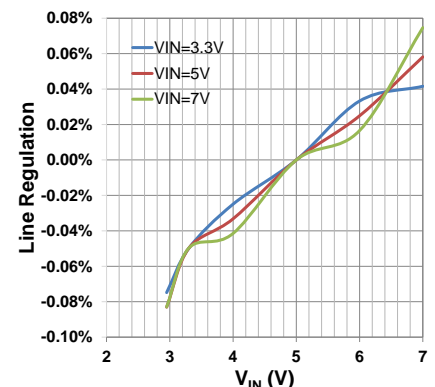
### Line Regulation

$V_{OUT}=1.8V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$

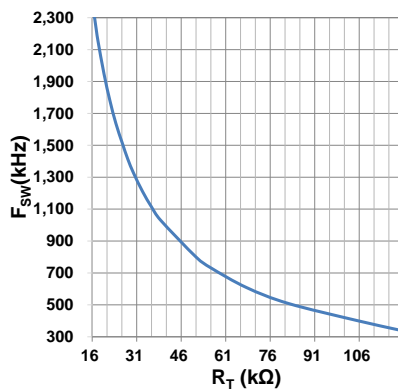


### Line Regulation

$V_{OUT}=1.2V$ ,  $F_{SW}=1MHz$ ,  $L=0.33\mu H$



### Frequency vs. RT Resistance

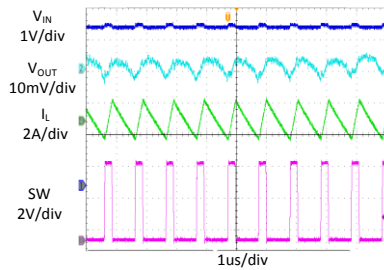


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

$V_{IN} = 5V$ ,  $V_{OUT} = 1.2V$ ,  $L = 0.33\mu H$ ,  $C_{OUT} = 104\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.

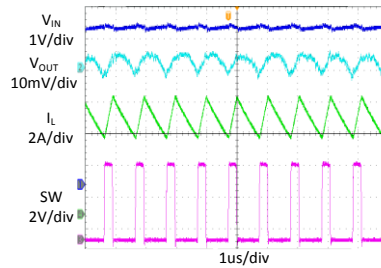
**Steady State**

$I_{OUT} = 0A$



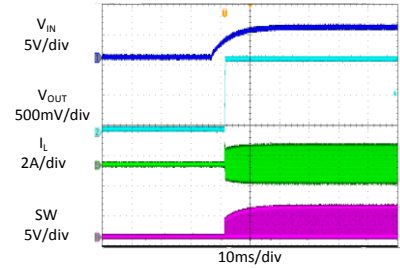
**Steady State**

$I_{OUT} = 6A$



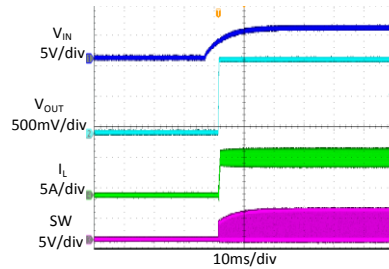
**Start-Up through VIN**

$I_{OUT} = 0A$



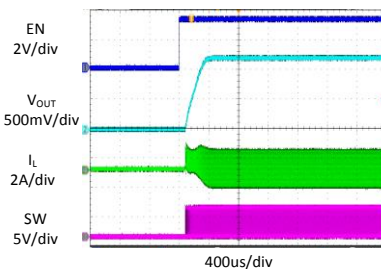
**Start-Up through VIN**

$I_{OUT} = 6A$



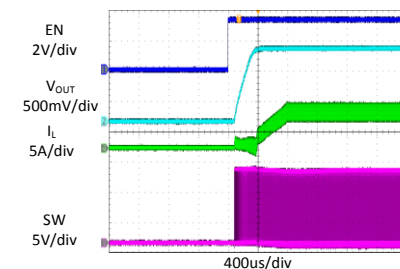
**Start-Up through Enable**

$I_{OUT} = 0A$



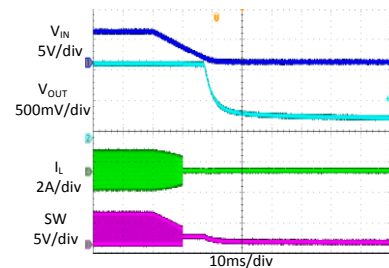
**Start-Up through Enable**

$I_{OUT} = 6A$



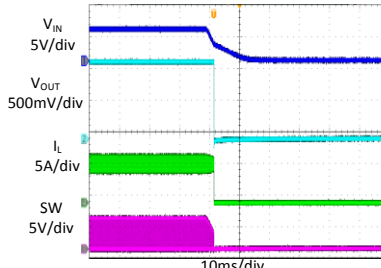
**Shutdown through VIN**

$I_{OUT} = 0A$



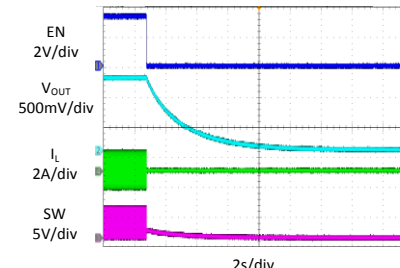
**Shutdown through VIN**

$I_{OUT} = 6A$



**Shutdown through Enable**

$I_{OUT} = 0A$

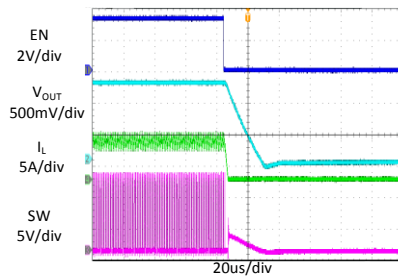


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

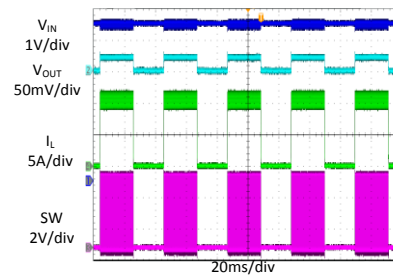
$V_{IN} = 5V$ ,  $V_{out} = 1.2V$ ,  $L = 0.33\mu H$ ,  $C_{out} = 104\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.

**Shutdown through Enable**

$I_{OUT} = 6A$

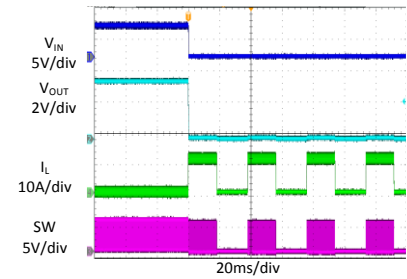


**SCP Steady State**



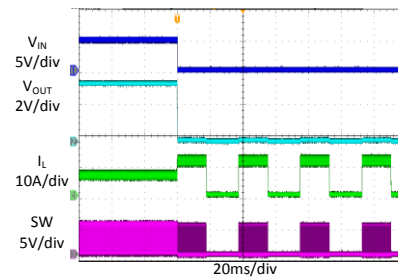
**SCP Entry**

$I_{OUT} = 0A$



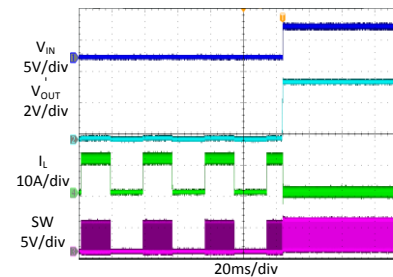
**SCP Entry**

$I_{OUT} = 6A$



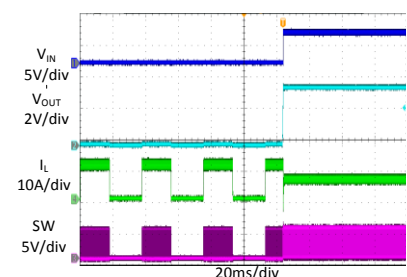
**SCP Recovery**

$I_{OUT} = 0A$



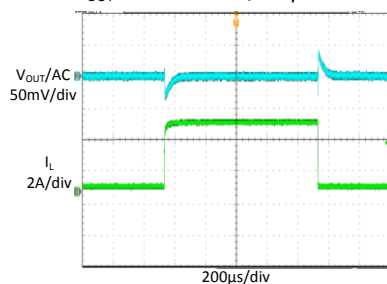
**SCP Recovery**

$I_{OUT} = 6A$



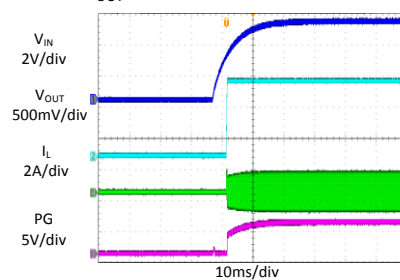
**Load Transient**

$I_{OUT} = 0.4A \leftrightarrow 4.5A$ ,  $1A/\mu s$



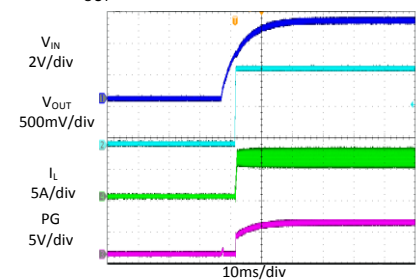
**PG in Start-Up through VIN**

$I_{OUT} = 0A$



**PG in Start-Up through VIN**

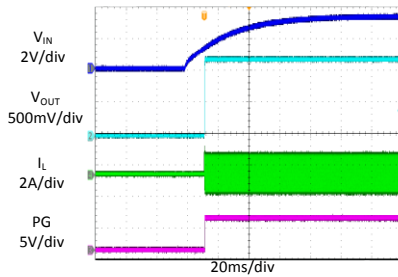
$I_{OUT} = 6A$



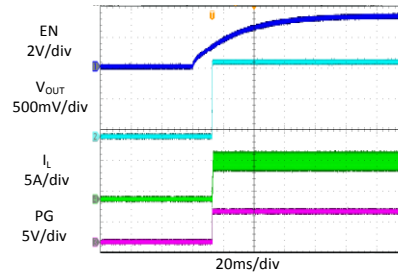
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

$V_{IN} = 5V$ ,  $V_{out} = 1.2V$ ,  $L = 0.33\mu H$ ,  $C_{out} = 104\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.

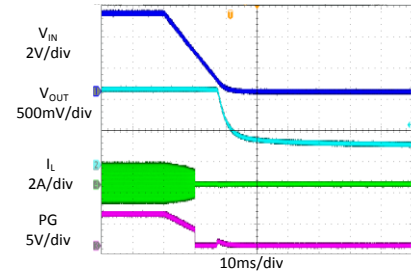
PG in Start-Up through Enable

 $I_{OUT}=0A$ 

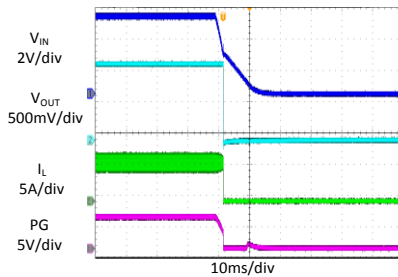
PG in Start-Up through Enable

 $I_{OUT}=6A$ 

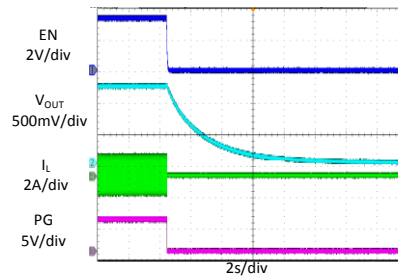
PG in Shutdown through VIN

 $I_{OUT}=0A$ 

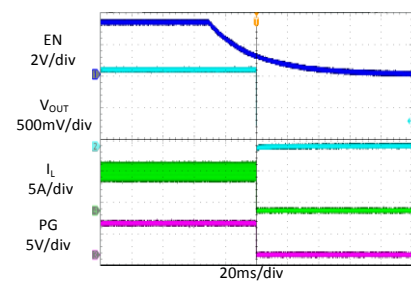
PG in Shutdown through VIN

 $I_{OUT}=6A$ 

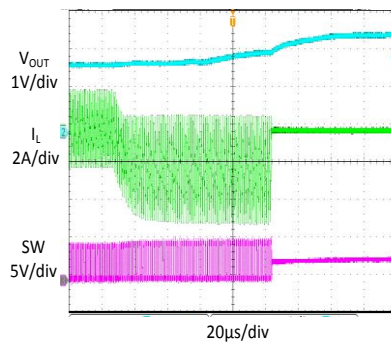
PG in Shutdown through Enable

 $I_{OUT}=0A$ 

PG in Shutdown through Enable

 $I_{OUT}=6A$ 

OVP



## FUNCTIONAL DESCRIPTION

The JWH5276 is a synchronous step-down regulator based on a proprietary I2 control for fast transient response. It regulates input voltages from 2.95V~7V down to an output voltage as low as 0.6V, and is capable of supplying up to 6A of load current.

### Forced Continuous Current Mode

The JWH5276 utilizes a settable fixed frequency, I2 control to regulate the output voltage. The output voltage is measured at the FB pin through a resistive voltage divider and the error is amplified by the internal transconductance error amplifier which drives the COMP pin. Output of the internal error amplifier is compared to the bottom switch current measured internally. When the bottom switch current drops below the COMP voltage level, the bottom switch is turned off and the top switch is allowed to turn on. A proper current ripple determined by the frequency set by RT pin is generated by the current ripple generator, and the sum of the current ripple and the error amplifier output is used as the top current reference. When the top current reaches this current reference, the top switch is turned off and the bottom switch is turned on. The COMP pin voltage increases and decreases as the output current increases and decreases.

### Shut-Down Mode

The JWH5276 operates in shut-down mode when EN is low. In shut-down mode, the entire regulator is off and the supply current consumed by the JWH5276 drops below 3uA.

### Power Switches

N-channel MOSFET switches are integrated on the JWH5276 to down convert the input voltage to the regulated output voltage.

### Enable and Adjustable VIN UVLO

The EN pin provides electrical on and off control of the device. Once the EN pin voltage exceeds the threshold voltage, the device starts operation. If the EN pin voltage is pulled below the threshold voltage, the regulator stops switching and enters low IQ state. If an application requires controlling the EN pin, use open drain or open collector output logic to interface with the pin.

For input under-voltage lockout (UVLO), use the EN pin as shown in Figure 1 to set up the UVLO by using a resistive divider connected between Vin and ground, with the central tap connected to EN. Once the EN pin voltage exceeds 1.3 V, an additional 2.95  $\mu$ A of hysteresis is added. This additional current facilitates input voltage hysteresis. Use Equation 1 and Equation 2 to set the input startup voltage and external hysteresis for the input voltage.

$$R_{EN\_H} = \frac{V_{STR} \left( \frac{V_{EN\_L}}{V_{EN\_H}} \right) - V_{STOP}}{i_p \times \left( 1 - \frac{V_{EN\_L}}{V_{EN\_H}} \right) + i_{hy}} \quad (1)$$

$$R_{EN\_L} = \frac{R_{EN\_H} \times V_{EN\_L}}{V_{STOP} - V_{EN\_L} + R_{EN\_H} \times (i_p + i_{hy})} \quad (2)$$

where  $R_{EN\_H}$  and  $R_{EN\_L}$  are in  $\Omega$ ,  $i_p=0.55\mu A$ ,  $i_{hy}=2.95\mu A$ ,  $V_{EN\_H}=1.3V$  and  $V_{EN\_L}=1.18V$ .

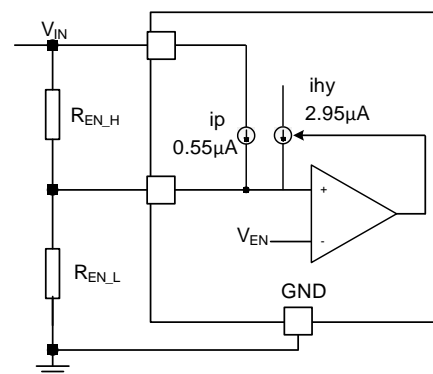


Figure 1. UVLO Setting

It is recommended that the minimum input shutdown voltage be set at 2.48 V or higher to ensure proper operation before shutdown.

### Current Limit and SCP

JWH5276 have protection against heavy load and short circuit events which switch current limits are designed in JWH5276. Excessive current might occur with a shorted or saturated inductor or a heavy load or shorted output circuit condition. If the inductor current reaches the threshold  $I_{LIM\_TOP}$ , the high-side MOSFET is turned off and the low-side MOSFET is turned on to ramp down the inductor current. Only when output current drops below the valley current limit  $I_{LIM\_BOT}$  can the top power switch be turned on again. When bottom switch current limit is triggered for 4150 consecutive switching cycles, the devices stop switching and discharge the internal soft-start capacitor. The devices then automatically start a new start-up after a typical delay time of 16ms has passed. The devices repeat this mode until the high load condition is removed.

### Soft-start

Soft-start is designed in JWH5276 to prevent the converter output voltage from overshooting during startup and short-circuit recovery. An internal current source ( $I_{SS}$ ) of 2uA is designed to charge the external soft-start capacitor ( $C_{SS}$ ) and generates a soft-start (SS) voltage ramping up from 0V to 1.8V. When it is less than internal reference voltage ( $V_{REF}$ , typ. 0.6V), SS voltage overrides  $V_{REF}$  and the error amplifier uses SS voltage as the reference. When SS exceeds  $V_{REF}$ ,  $V_{REF}$  regains control.

$T_{SS}$  can be calculated by the equation 3.

$$T_{SS}(ms) = V_{OUT} \times \frac{C_{SS}(nF) \times V_{REF}(V)}{I_{SS}(\mu A)} \quad (3)$$

At power up, the soft start pin is discharged before MOSFETs switching to ensure a proper

power up. Also, during normal operation, the JWH5276 will stop switching and the soft-start pin will be discharged, when the VIN UVLO is exceeded, EN pin pulled below 1.18V, or a thermal shutdown event occurs.

### Output Over-voltage Protection

JWH5276 incorporates an over-voltage transient protection circuit to minimize voltage overshoot when recovering from output fault conditions or strong unload transients. The OVP feature minimizes the output overshoot by implementing a circuit to compare the FB pin voltage to OVP threshold which is 116.5% of the internal voltage reference. If the FB pin voltage is greater than the OVP threshold, the top switch is disabled preventing current from flowing to the output and minimizing output overshoot. And then the bottom switch is turned-on until its current hit the negative current limit or the FB voltage drops lower than the OVP threshold. When the FB voltage drops lower than the OVP threshold, the top switch is allowed to turn on again.

### Adjustable Frequency

The switching frequency of JWH5276 can be programmed by the resistor  $R_T$  from the RT pin and GND pin over a wide range from 400 kHz to 2000 kHz. The RT pin voltage is typically 0.5V and must have a resistor to ground to set the switching frequency. The  $R_T$  resistance can be estimated by equation 4 for a given switching frequency  $F_{SW}$ .

$$R_T(k\Omega) = \frac{57761}{F_{SW}(kHz)^{1.052}} \quad (4)$$

The calculated  $R_T$  resistance might need fine-tuning according to bench test. You can also reach to Frequency vs.  $R_T$  Resistance Curve in TPC section to find the proper value.

To reduce the solution size one would typically

set the switching frequency as high as possible, but tradeoffs of the conversion efficiency, maximum input voltage and minimum controllable on time should be considered. The minimum controllable on time is typically 110 ns which limit the maximum operating frequency in applications with high input to output step down ratios.

### **Power Good**

JWH5276 has a built in power good (PG) function to indicator whether the output voltage has reached its appropriate level or not. The PG signal can be used for startup sequencing for multiple rails. The PG pin is an open drain output. It can sink 2mA of current and maintain its specified logic low level.

The PG indicator is in a valid state once the VIN

input voltage is greater than 1.2V. JWH5276 features PG=Low when the device is turned-off due to EN UVLO, VIN UVLO or thermal shutdown. After startup, PG is pulled high with a 15 $\mu$ s deglitch time when FB voltage reaches 93.5% of the REF voltage.

When FB voltage drops to 91.5% of the REF voltage, or exceeds 116.5% of the nominal REF voltage, PG is pulled low with a 13us deglitch time.

### **Thermal Protection**

When the temperature of the JWH5276 rises above 170°C, it is forced into thermal shut-down. Only when core temperature drops below 150°C can the regulator becomes active again.

## APPLICATION INFORMATION

### Output Voltage Set

The output voltage is determined by the resistor divider connected at the FB pin, and the voltage ratio is:

$$V_{FB} = V_{OUT} \times \frac{R10}{R9 + R10}$$

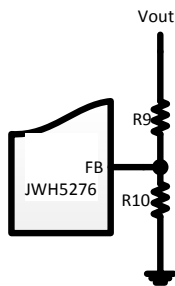
where  $V_{FB}$  is the feedback voltage and  $V_{OUT}$  is the output voltage.

Choose  $R9$  around 10K $\Omega$ , and then  $R10$  can be calculated by:

$$R10(k\Omega) = \frac{0.6 \times R9}{V_{OUT} - 0.6}$$

The following table lists the recommended values.

VOUT(V)	R9(K $\Omega$ )	R10(K $\Omega$ )
0.7	10	60
1.2	10	10
2.5	10	3.16
3.3	10	2.2
3.7	10	1.91



### Input Capacitor Selection

The input capacitor is used to supply the AC input current to the step-down converter and maintaining the DC input voltage. The ripple current through the input capacitor can be calculated by:

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}$$

where  $I_{LOAD}$  is the load current,  $V_{OUT}$  is the output voltage,  $V_{IN}$  is the input voltage.

Thus the input capacitor can be calculated by the following equation when the input ripple voltage is determined.

$$C_1 = \frac{I_{LOAD}}{F_{SW} \times \Delta V_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

where  $C_1$  is the input capacitance value,  $F_{SW}$  is the switching frequency,  $\Delta V_{IN}$  is the input ripple voltage.

The input capacitor can be electrolytic, tantalum or ceramic. To minimizing the potential noise, a small X5R or X7R ceramic capacitor, i.e. 0.1 $\mu$ F, should be placed as close to the IC as possible when using electrolytic capacitors.

A 22 $\mu$ F/0805/6.3V ceramic capacitor is recommended in typical application.

### Output Capacitor Selection

The output capacitor is required to maintain the DC output voltage, and the capacitance value determines the output ripple voltage. The output voltage ripple can be calculated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{F_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times F_{SW} \times C_2}\right)$$

where  $C_2$  is the output capacitance value and  $R_{ESR}$  is the equivalent series resistance value of the output capacitor.

The output capacitor can be low ESR electrolytic, tantalum or ceramic, which lower ESR capacitors get lower output ripple voltage.

The output capacitors also affect the system



stability and transient response, and 44uF~88uF ceramic capacitor are recommended in typical application.

### Inductor Selection

The inductor is used to supply constant current to the output load, and the value determines the ripple current which affect the efficiency and the output voltage ripple. The ripple current is typically allowed to be 30% of the maximum switch current limit, thus the inductance value can be calculated by:

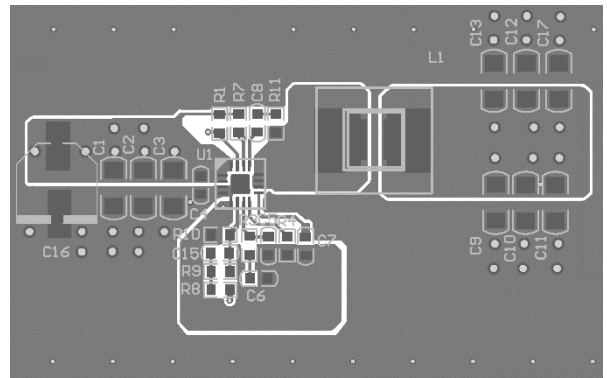
$$L = \frac{V_{OUT}}{F_{SW} \times \Delta I_L} \times \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

where  $V_{IN}$  is the input voltage,  $V_{OUT}$  is the output voltage,  $F_{SW}$  is the switching frequency, and  $\Delta I_L$  is the peak-to-peak inductor ripple current.

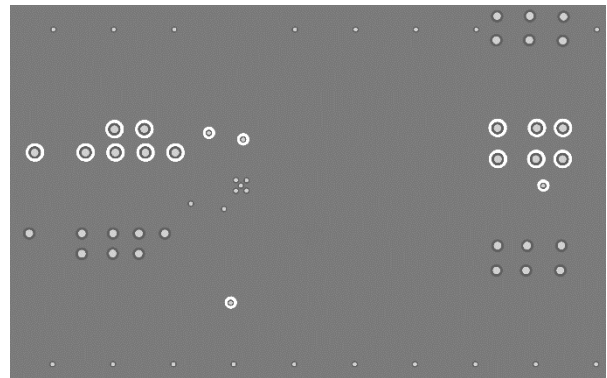
### PCB Layout Guidelines <sup>(6)</sup>

For minimum noise problem and best operating performance, the PCB is preferred to following the guidelines as reference.

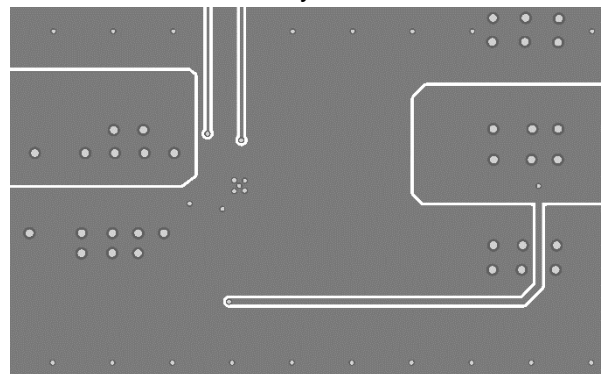
1. Place the input decoupling capacitor as close to JWH5276 ( $V_{IN}$  pin and PGND) as possible to eliminate noise at the input pin. The loop area formed by input capacitor and GND must be minimized.
2. Put the feedback trace as short as possible, and far away from the inductor and noisy power traces like SW node.
3. The ground plane on the PCB should be as large as possible for better heat dissipation.
4. Keep the switching node SW short to prevent excessive capacitive coupling.
5. Make  $V_{IN}$ ,  $V_{OUT}$  and ground bus connections as wide as possible. This reduces any voltage drops on the input or output paths of the converter and maximizes efficiency.



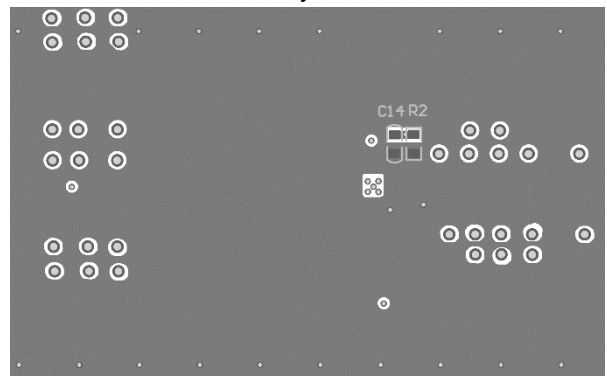
Top and Top Silk Layer



Mid-Layer1



Mid-Layer2



Bottom and Bottom Silk Layer

Notes:

- 6) The Recommended PCB layout is based on Reference 1

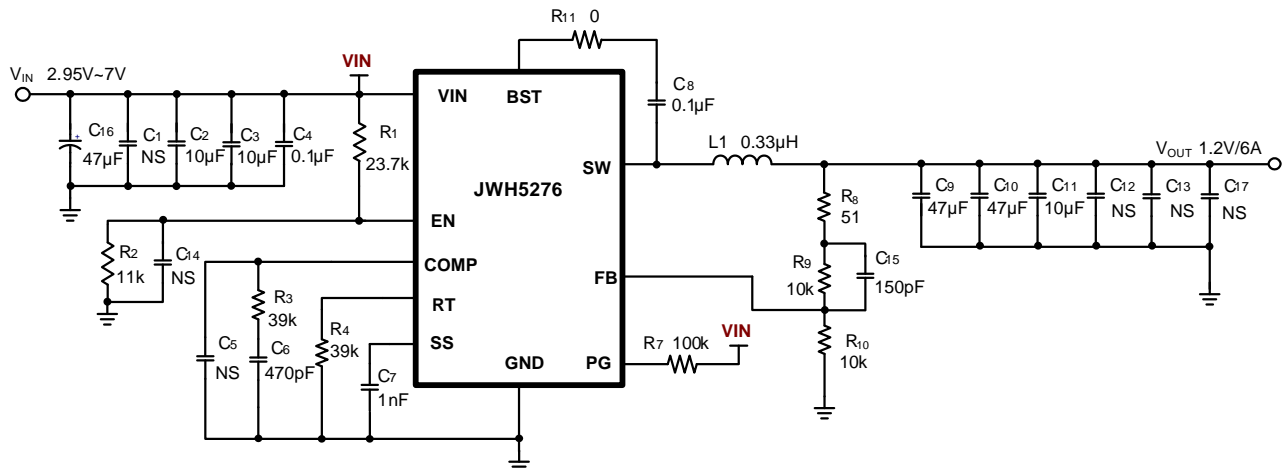
## REFERENCE DESIGN

## Reference 1:

$V_{IN}$  : 2.95V~7V

$V_{OUT}$  : 1.2V

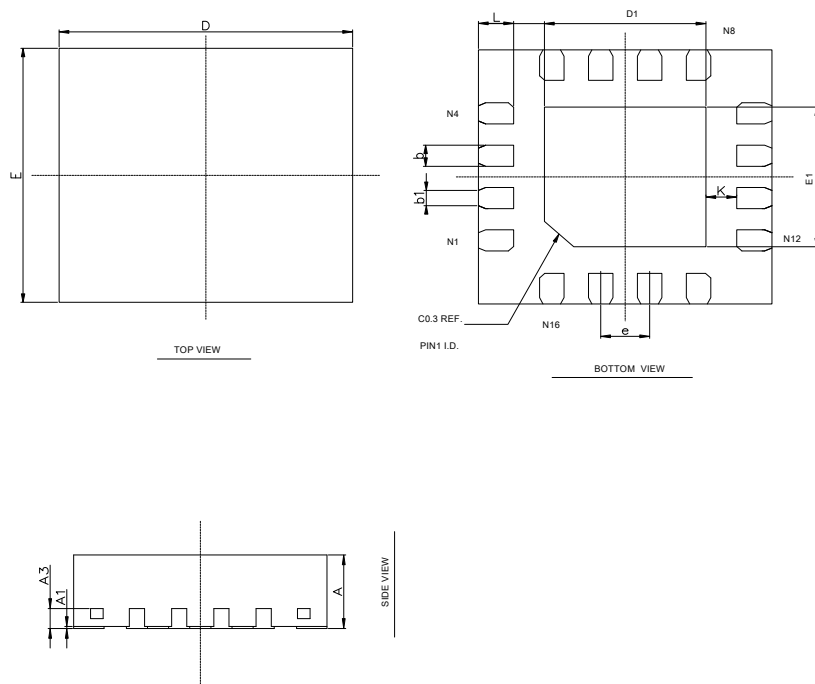
$I_{OUT}$  : 0~6A



## PACKAGE OUTLINE

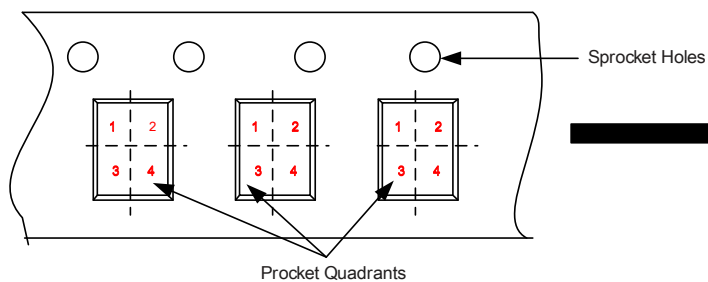
QFN3X3-16

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	—	0.05
A3	0.203REF		
D	2.90	3.00	3.10
E	2.90	3.00	3.10
D1	1.55	1.65	1.75
E1	1.55	1.65	1.75
k	0.315REF		
b	0.20	—	0.30
b1	0.18BCS		
e	0.50BCS		
L	0.26	—	0.46

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPAE



Package Type	Pin1 Quadrant
QFN3X3-16	1

**IMPORTANT NOTICE**

- Joulwatt Technology Inc. reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein.
- Any unauthorized redistribution or copy of this document for any purpose is strictly forbidden.
- Joulwatt Technology Inc. does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

*Copyright © 2019 JWH5276 Incorporated.*

*All rights are reserved by Joulwatt Technology Inc.*